

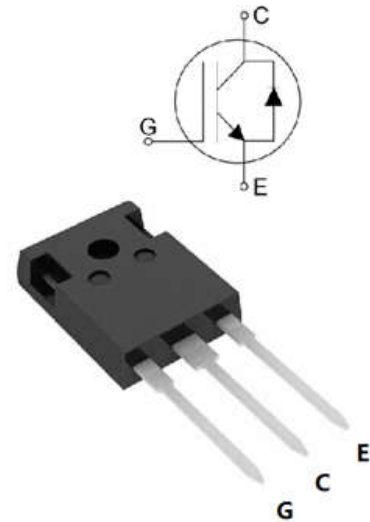
### FEATURES

- High breakdown voltage up to 650V for improved reliability
- Trench-Stop Technology offering :
  - High speed switching
  - High ruggedness, temperature stable
  - Low  $V_{CEsat}$
  - Easy parallel switching capability due to positive temperature coefficient in  $V_{CEsat}$
- Enhanced avalanche capability

$V_{CE}$	<b>650</b>	<b>V</b>
$I_C$	<b>60</b>	<b>A</b>
$V_{CE(SAT)} I_C=60A$	<b>1.85</b>	<b>V</b>

### APPLICATION

- Uninterruptible Power Supplies
- Inverter
- Welding Converters
- PFC applications
- Converter with high switching frequency



Product	Package	Packaging
YGW60N65F1A2	TO247	Tube

**Maximum Ratings** ( $T_j = 25^\circ\text{C}$  unless otherwise specified)

Parameter	Symbol	Value	Unit
Collector-Emitter Breakdown Voltage	$V_{CE}$	650	V
DC collector current, limited by $T_{jmax}$ $T_C = 25^\circ\text{C}$ $T_C = 100^\circ\text{C}$	$I_C$	120 60	A
Diode Forward current, limited by $T_{jmax}$ $T_C = 25^\circ\text{C}$ $T_C = 100^\circ\text{C}$	$I_F$	80 40	A
Continuous Gate-emitter voltage	$V_{GE}$	$\pm 20$	V
Transient Gate-emitter voltage	$V_{GE}$	$\pm 30$	V
Turn off safe operating area $V_{CE} \leq 650\text{V}$ , $T_j \leq 175^\circ\text{C}$	-	180	A
Pulse collector current, $V_{GE} = 15\text{V}$ , $t_p$ limited by $T_{jmax}$	$I_{CM}$	180	A
Power dissipation, $T_j = 25^\circ\text{C}$	$P_{tot}$	312	W
Operating junction temperature	$T_j$	$-40 \dots +175$	$^\circ\text{C}$
Storage temperature	$T_S$	$-55 \dots +175$	$^\circ\text{C}$
Soldering temperature, wave soldering 1.6mm (0.063in.) from case for 10s	-	260	$^\circ\text{C}$
Mounting torque, M3 screw Maximum of mounting processes: 3	$M$	0.6	Nm

**Thermal Resistance**

Parameter	Symbol	Max. Value	Unit
IGBT thermal resistance, junction - case	$R_{\theta(j-c)}$	0.48	K/W
Diode thermal resistance, junction - case	$R_{\theta(j-c)}$	1.1	K/W
Thermal resistance, junction - ambient	$R_{\theta(j-a)}$	40	K/W

**Electrical Characteristics** ( $T_j = 25^\circ\text{C}$  unless otherwise specified)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
<b>Static</b>						
Collector-Emitter Breakdown Voltage	$BV_{CES}$	$V_{GE}=0V, I_C=250\mu A$	650	-	-	V
		$V_{GE}=0V, I_C=1mA$	650	-	-	V
Gate Threshold Voltage	$V_{GE(th)}$	$V_{GE}=V_{CE}, I_C=250\mu A$	4.0	5.0	6.0	V
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$V_{GE}=15V, I_C=60A$	-	1.85	2.2	V
		$T_j = 175^\circ\text{C}$	-	2.55	-	
Zero gate voltage collector current	$I_{CES}$	$V_{CE} = 650V, V_{GE} = 0V$	-	0.1	40	$\mu A$
		$T_j = 175^\circ\text{C}$	-	-	4000	
Gate-emitter leakage current	$I_{GES}$	$V_{CE} = 0V, V_{GE} = \pm 20V$	-	-	100	nA
Transconductance	$g_{fs}$	$V_{CE} = 20V, I_C = 60A$	-	52	-	S

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
<b>Dynamic</b>						
Input capacitance	$C_{ies}$	$V_{CE} = 30V, V_{GE} = 0V,$ $f = 1\text{ MHz}$	-	3800	-	pF
Output capacitance	$C_{oes}$		-	130	-	
Reverse transfer capacitance	$C_{res}$		-	70	-	
Gate charge	$Q_G$	$V_{CC} = 520V, I_C = 60A,$ $V_{GE} = 15V$	-	158	-	nC

**Switching Characteristic, Inductive Load**

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
<b>Dynamic <math>T_j=25^\circ\text{C}</math></b>						
Turn-on Delay Time	$t_{d(\text{on})}$	$V_{\text{CC}} = 400\text{V}, I_{\text{C}} = 60.0\text{A},$ $V_{\text{GE}} = 0.0/15.0\text{V},$ $R_{\text{g}}=12\Omega$	-	56	-	ns
Rise Time	$t_{\text{r}}$		-	79	-	ns
Turn-off Delay Time	$t_{d(\text{off})}$		-	165	-	ns
Fall Time	$t_{\text{f}}$		-	81	-	ns
Turn-on Energy	$E_{\text{on}}$		-	2.2	-	mJ
Turn-off Energy	$E_{\text{off}}$		-	0.89	-	mJ

**Electrical Characteristics of the DIODE** ( $T_j = 25^\circ\text{C}$  unless otherwise specified)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
<b>Dynamic</b>						
Diode Forward Voltage	$V_{\text{FM}}$	$I_{\text{F}} = 40\text{A}$	-	1.8	-	v
Reverse Recovery Time	$T_{\text{rr}}$	$I_{\text{F}}= 60\text{A},$ $V_{\text{R}} = 400\text{V},$ $di/dt= 400\text{A}/\mu\text{s},$	-	90	-	ns
Reverse Recovery Current	$I_{\text{rr}}$		-	12	-	A
Reverse Recovery Charge	$Q_{\text{rr}}$		-	600	-	nC

Fig. 1 FBSOA characteristics

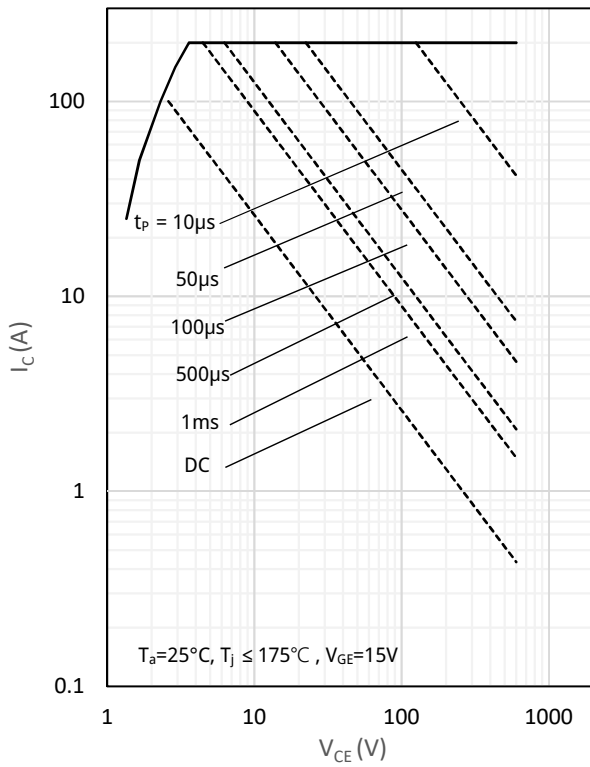


Fig. 2 Power dissipation as a function of  $T_c$

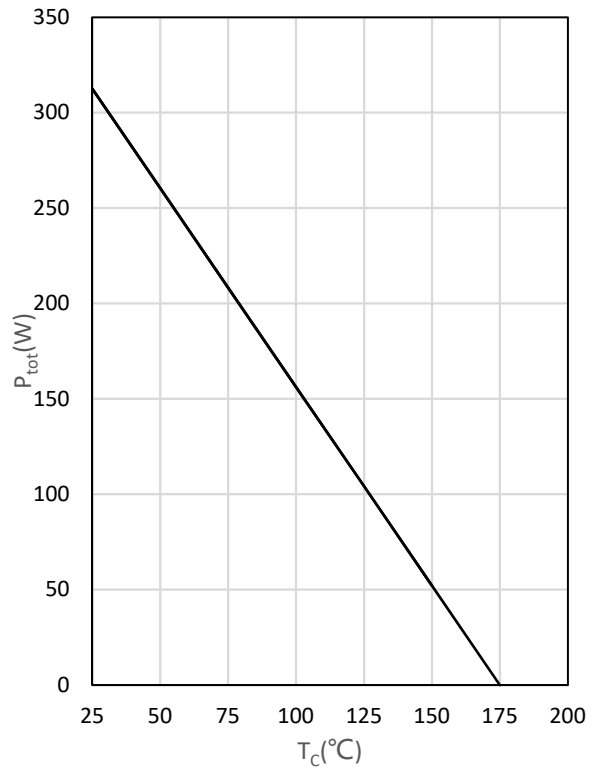


Fig. 3 Output characteristics

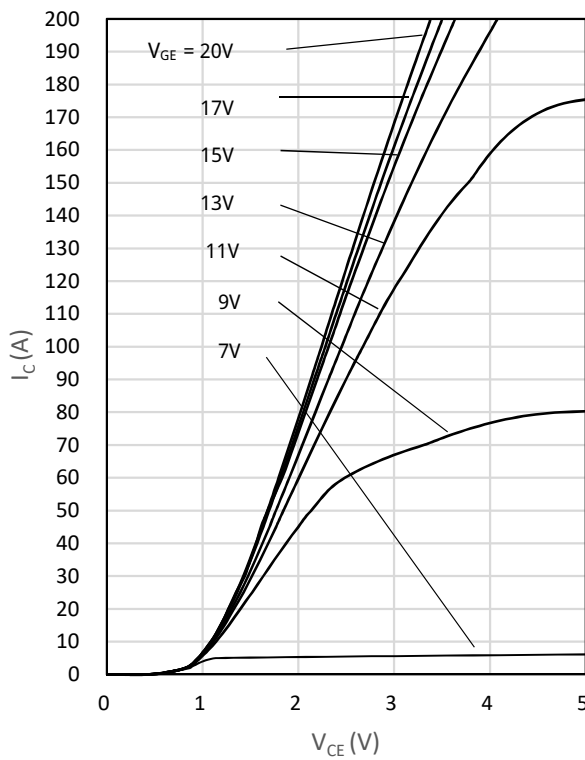


Fig. 4 Saturation voltage characteristics

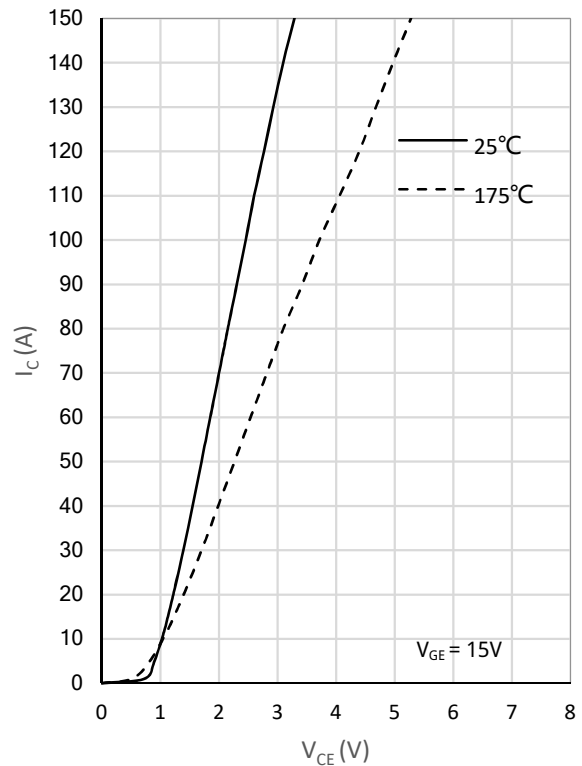


Fig. 5 Switching times vs. gate resistor

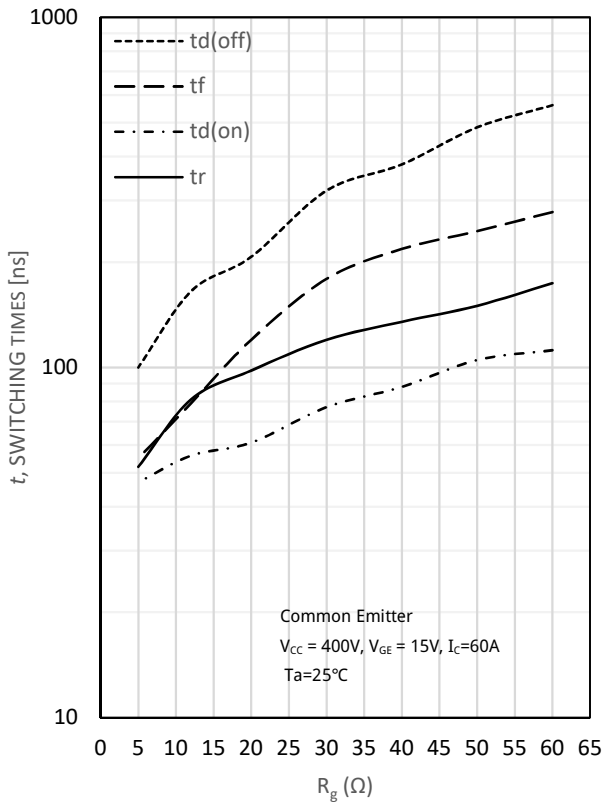


Fig. 6 Switching times vs. collector current

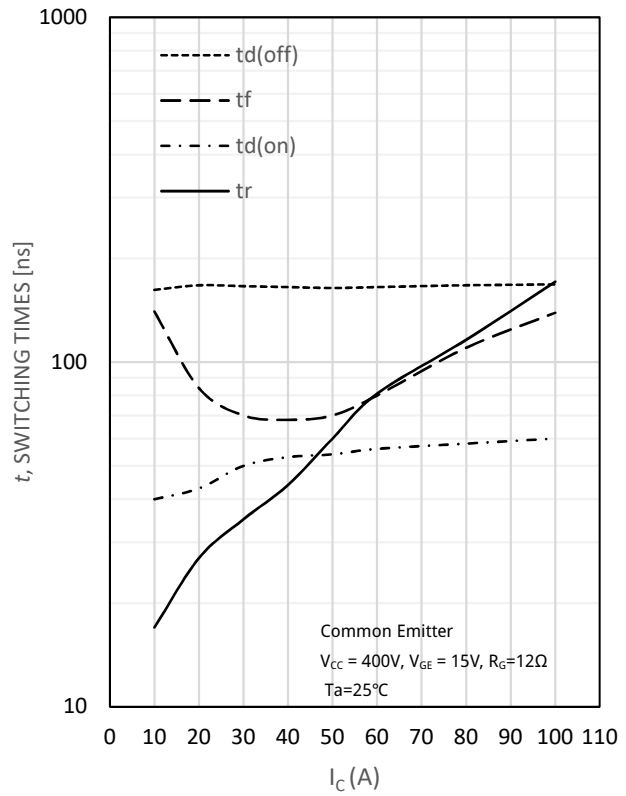


Fig. 7 Switching loss vs. gate resistor

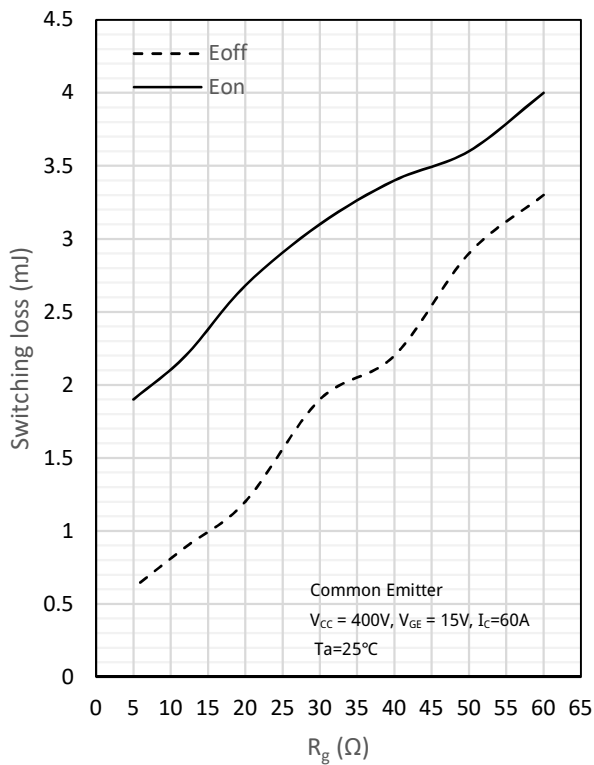


Fig. 8 Switching loss vs. collector current

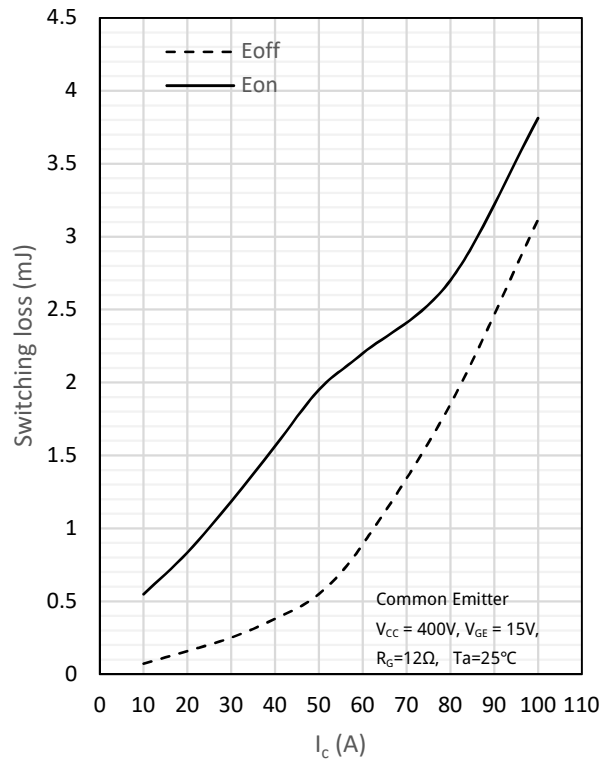


Fig. 9 Gate charge characteristics

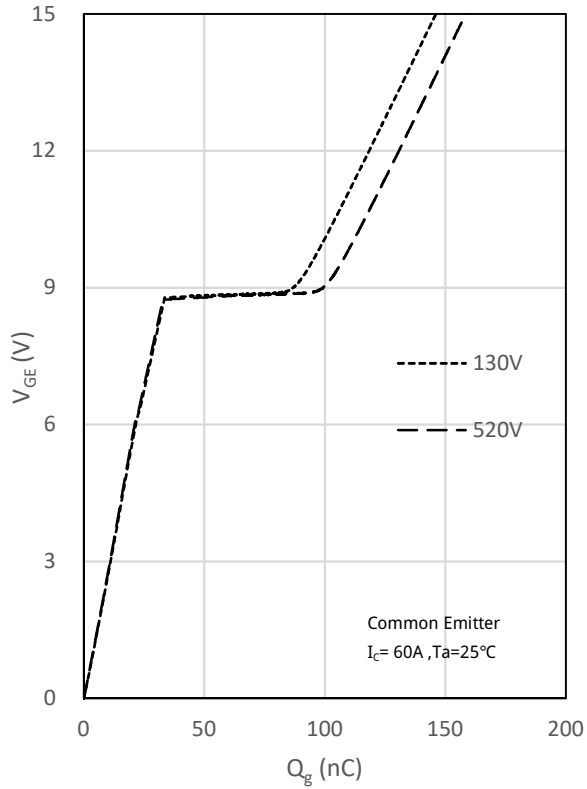
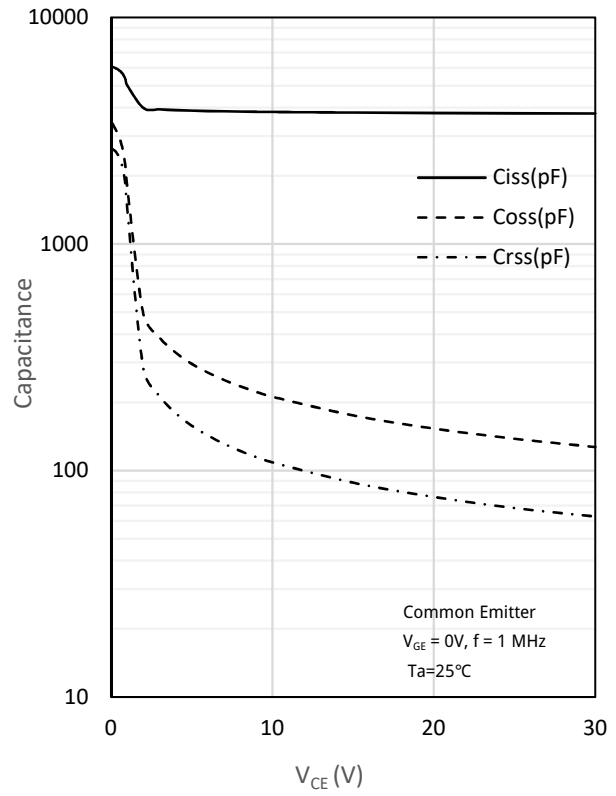
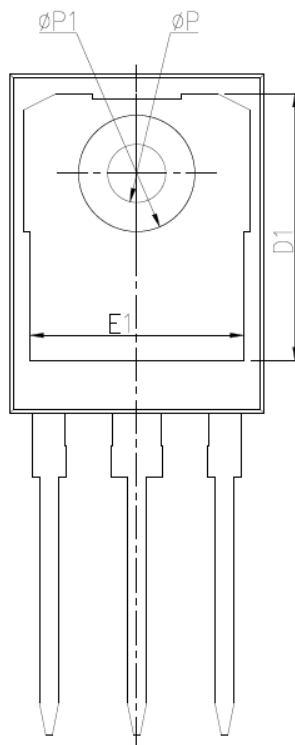
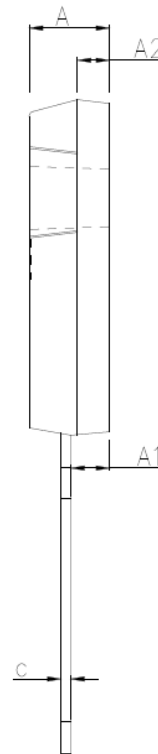
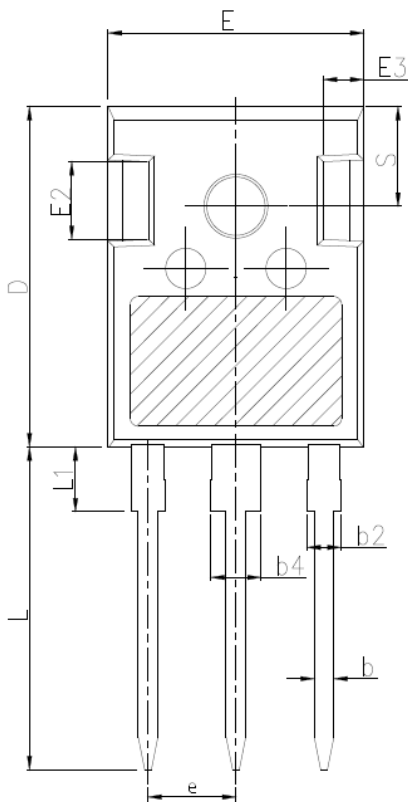


Fig. 10 Capacitance characteristics



## TO247 package information



COMMON DIMENSIONS

SYMBOL	mm		
	MIN	NOM	MAX
A	4.80	5.00	5.20
A1	2.21	2.41	2.59
A2	1.85	2.00	2.15
b	1.11	1.21	1.36
b2	1.91	2.01	2.21
b4	2.91	3.01	3.21
c	0.51	0.61	0.75
D	20.80	21.00	21.30
D1	16.25	16.55	16.85
E	15.50	15.80	16.10
E1	13.00	13.30	13.60
E2	4.80	5.00	5.20
E3	2.30	2.50	2.70
e	5.44BSC		
L	19.82	19.92	20.22
L1	-	-	4.30
$\Phi P$	3.40	3.60	3.80
$\Phi P1$	-	-	7.30
S	6.15BSC		